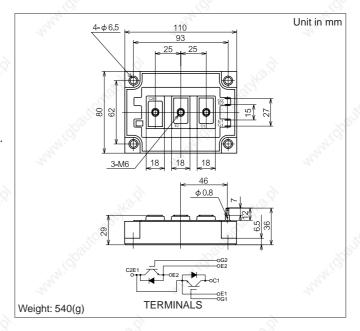
MBM300GS12AW

Silicon N-channel IGBT

OUTLINE DRAWING

FEATURES

- * High speed and low saturation voltage.
- * low noise due to built-in free-wheeling diode ultra soft fast recovery diode(USFD).
- * Isolated head sink (terminal to base).



ABSOLUTE MAXIMUM RATINGS (Tc=25°C)

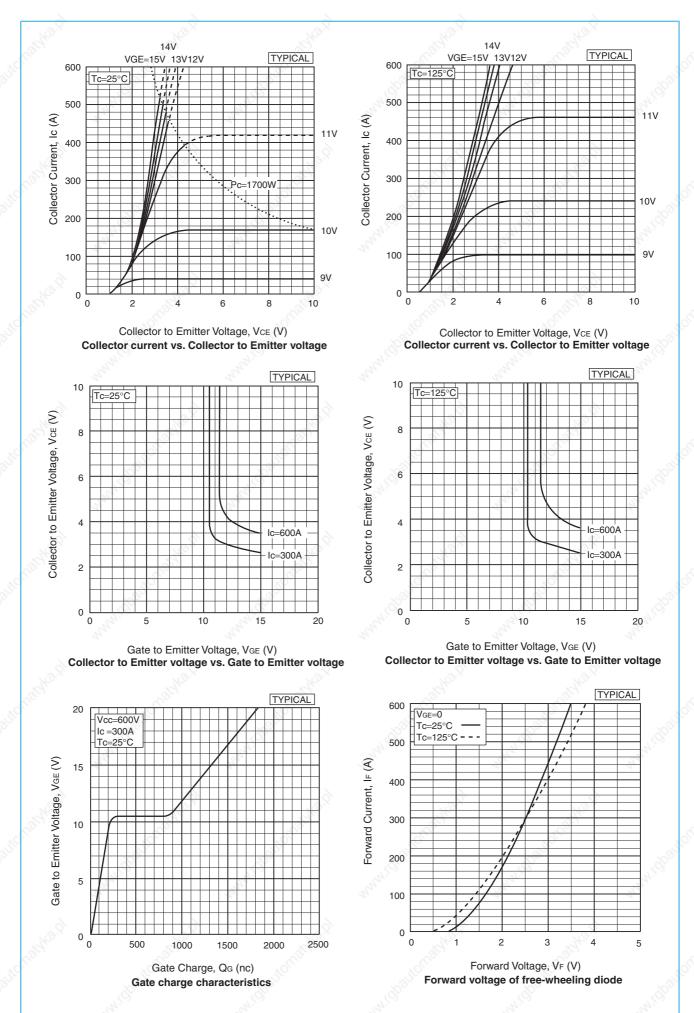
V 1 1/		, ,	17			
Item	USEA,	Symbol	Unit	MBM300GS12AW		
Collector Emitter Voltage		Vces	V	1,200		
Gate Emitter Voltage		V_{GES}	V W	±20		
Collector Current	DC	Ic	A	300		
200	1ms	I _{Cp}	A	600		
Forward Current	DC	IF	Α	300 (1)		
	1ms	I _{FM}	9 A	600		
Collector Power Dissipation		Pc	€ W	1,700		
Junction Temperatur	e 🐬	Tj 🎺	°C	-40 ~ +150		
Storage Temperature		T _{stg}	°C	-40 ~ +125		
Isolation Voltage		V _{ISO}	V _{RMS}	2,500(AC 1 minute)		
Screw Torque	Terminals	21/2 -	N.m	2.94(30) (2)		
	Mounting	-	(kgf.cm)	2.94(30) (3)		

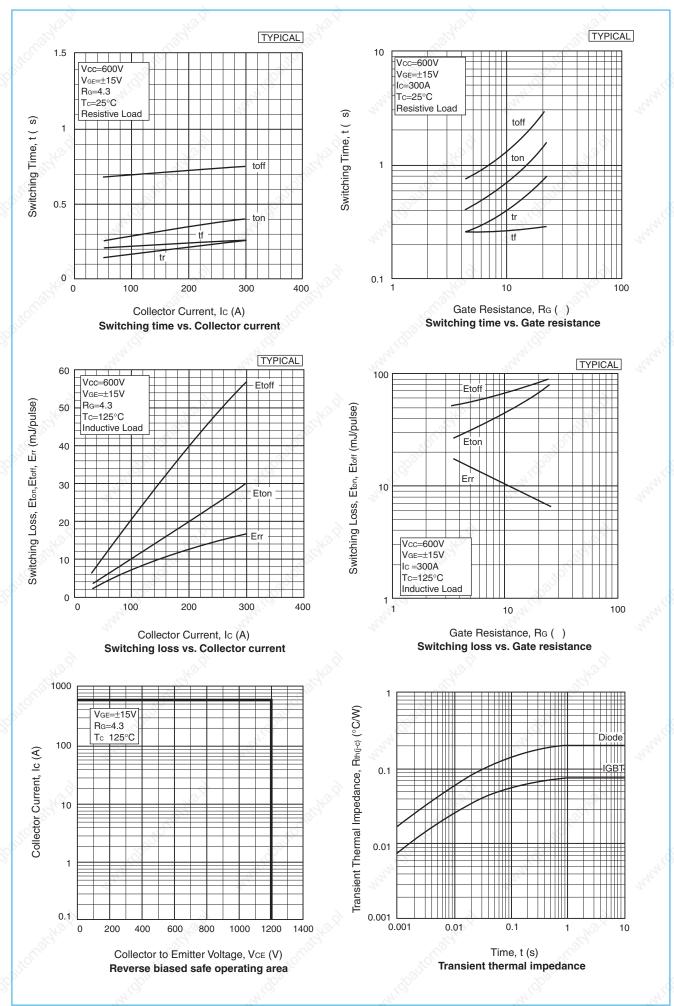
Notes:(1)RMS Current of Diode 90Arms max. (2)(3)Recommended Value 2.45N.m(25kgf.cm)

CHARACTERISTICS (Tc=25°C)

OT IT IT TO TENTO	1100 (10 20 0)				\sim		V.	
Item		Symbol	Unit	Min.	Тур.	Max.	Test Conditions	
Collector Emitter Cut-Off Current		I _{CES}	mA	- 4	(5).	1.0	V _{CE} =1,200V,V _{GE} =0V	71,0
Gate Emitter Leakage Current		I _{GES}	nA	12/19	-	±500	V _{GE} =±20V,V _{CE} =0V	444
Collector Emitter Saturation Voltage		V _{CE(sat)}	V	-	2.7	3.4	Ic=300A,V _{GE} =15V	
Gate Emitter Threshold Voltage		V _{GE(TO)}	V	-	-	10	V _{CE} =5V, I _C =300mA	
Input Capacitance		Cies	pF	-	28,000	VIB.X	V _{CE} =10V,V _{GE} =0V,f=1MHz	
Switching Times	Rise Time	tr	17/1	-	0.25	0.5	V _{CC} =600V	
	Turn On Time	ton	μS	-	0.4	0.7	R _L =2.0Ω	
	Fall Time	t _f		-	0.25	0.35	$R_G=4.3\Omega$	(4)
	Turn Off Time	t_{off}		- ,	0.75	1.1	V _{GE} =±15V	
Peak Forward Voltage Drop		V _{FM}	V	-44	2.5	3.5	I _F =300A,V _{GE} =0V	My.
Reverse Recovery Time		trr	μS	14	-	0.35	I _F =300A,V _{GE} =-10V, di/dt=400A/μs	
Thermal Impedance IGBT		Rth(j-c)	°C/W	-	-	0.073	Junction to case	
9	FWD	Rth(j-c)	- 9	-	-	0.2	. 6	

Notes:(4) R_G value is the test condition's value for decision of the switching times, not recommended value. Determine the suitable R_G value after the measurement of switching waveforms (overshoot voltage,etc.)with appliance mounted.





HITACHI POWER SEMICONDUCTORS

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